UTC UNISONIC TECHNOLOGIES CO., LTD

15N60 **Power MOSFET**

15A, 600V N-CHANNEL **POWER MOSFET**

DESCRIPTION

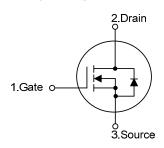
The UTC 15N60 is an N-channel mode power MOSFET using UTC's advanced technology to provide costumers with planar stripe and DMOS technology. This technology is specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

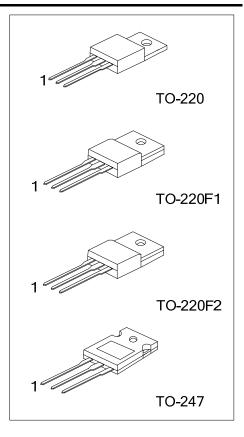
The UTC 15N60 is universally applied in active power factor correction and high efficient switched mode power supplies.

FEATURES

- * $R_{DS(ON)}$ < 0.65 Ω @ V_{GS} =10V, I_{D} =7.5A
- * High switching speed
- * Improved dv/dt capability

SYMBOL

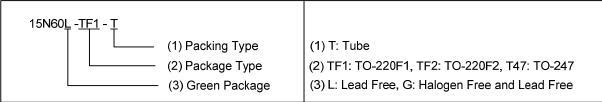




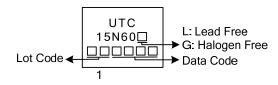
RDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
15N60L-TF1-T	15N60G-TF1-T	TO-220	G	D	S	Tube	
15N60L-TF1-T	15N60G-TF1-T	TO-220F1	G	D	S	Tube	
15N60L-TF2-T	15N60G-TF2-T	TO-220F2	G	D	S	Tube	
15N60L-T47-T	15N60G-T47-T	TO-247	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain to Source Voltage		V_{DSS}	600	V
Gate to Source Voltage		V_{GSS}	±30	V
Continuous Drain Current	Continuous	I_{D}	15	Α
	Pulsed (Note 2)	I _{DM}	60	Α
Avalanche Current (Note 2)		I_{AR}	6.4	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	205	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.45	V/ns
Power Dissipation	TO-220	P _D	250	W
	TO-220F1		54	W
	TO-220F2		52	W
	TO-247		312	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=10mH, I_{AS} =6.4A, V_{DD} = 50V, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C
- 4. $I_{SD} \le 15A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL RESISTANCES CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F1 TO-220F2	θ _{JA}	62.5	°C/W
	TO-247		40	°C/W
Junction to Case	TO-220	θлс	0.5	°C/W
	TO-220F1		2.3	°C/W
	TO-220F2		2.4	°C/W
	TO-247		0.4	°C/W

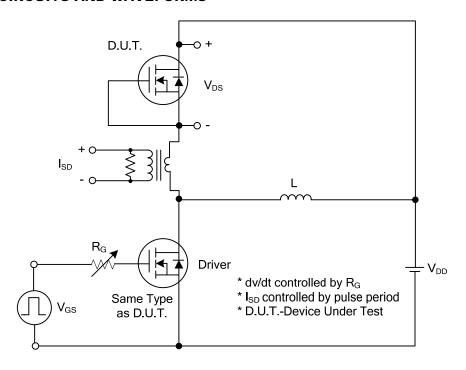
■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	V_{GS} =0V, I_D =250 μ A	600			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V			1	μΑ	
Gate- Source Leakage Current	Forward	- I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA	
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$			4.0	V	
Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =7.5A			0.65	Ω	
DYNAMIC PARAMETERS		-		-	-	ā		
Input Capacitance	nput Capacitance				2600		рF	
Output Capacitance		Coss	V _{DS} =25V,V _{GS} =0V,f=1.0MHz		260		pF	
Reverse Transfer Capacitance		C_{RSS}	<u> </u>		22		рF	
SWITCHING PARAMETERS		-		-	-	ā		
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		155		nC	
Gate-Source Charge		Q_GS	$I_{G} = 100 \mu A \text{ (Note 1, 2)}$		14		nC	
Gate-Drain Charge		Q_GD	IG = 100μA (Note 1, 2)		28		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			105		ns	
Turn-ON Rise Time		t_R	$V_{DD} = 30V, V_{GS} = 10V, I_D = 0.5A,$		115		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1, 2)		600		ns	
urn-OFF Fall Time		t_{F}			120		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is				15	Α	
Maximum Body-Diode Pulsed Current (Note 1)		I _{SM}				60	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =15A, V _{GS} =0V			1.4	V	
Body Diode Reverse Recovery Time		t _{rr}	I _S =15A, V _{GS} =0V,		510		ns	
Body Diode Reverse Recovery Charge		Qrr	dI _F /dt=100A/µs (Note 1)		8.2		μC	

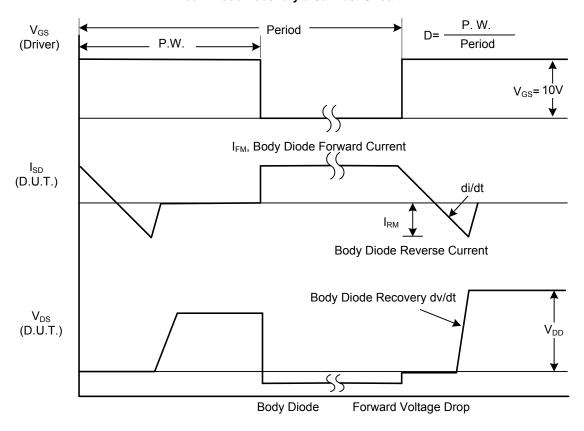
Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

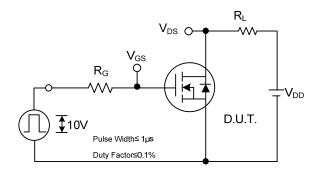


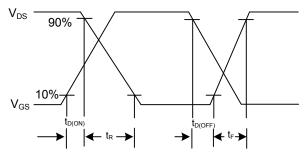
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

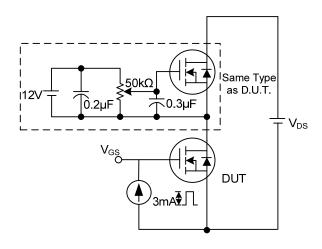
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

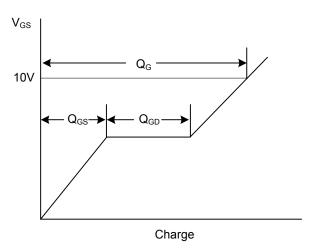




Switching Test Circuit

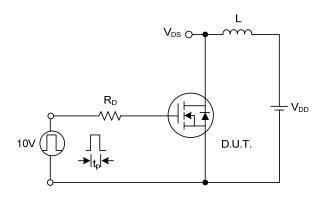
Switching Waveforms

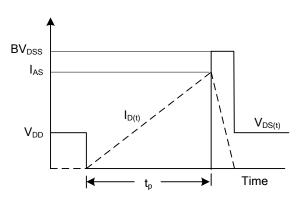




Gate Charge Test Circuit

Gate Charge Waveform

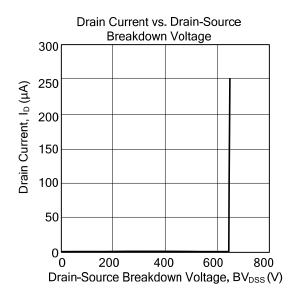


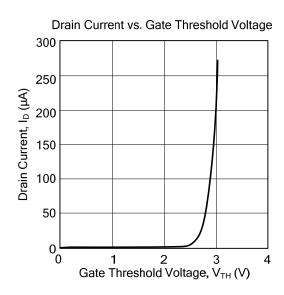


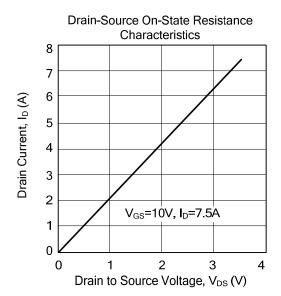
Unclamped Inductive Switching Test Circuit

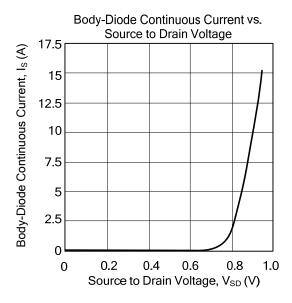
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









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